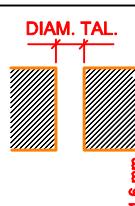
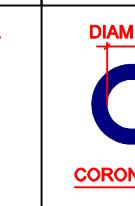
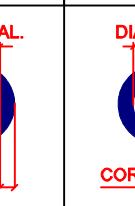
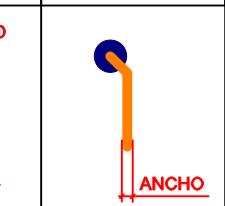
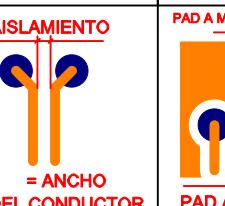


 Ed.6 - 21/02/22	Diámetro mínimo taladro FINAL (mm)	Corona mínima VÍAS. (taladro FINAL) (mm)	Corona mínima pads EXT. (taladro FINAL) (mm)	Corona mínima pads INT. (taladro FINAL) (mm)	Aislamiento mínimo antipads INT. (taladro FINAL) (mm)	Oversize mínimo máscaras-Cu (mm)	Ancho mínimo conductor (mm)	Aislamiento mínimo conductores (mm)	Aislamiento mínimo de pad a pista ó masa de cobre (mm)
CLASE 3	(0.7)	(PAD 1.2) (0.25)	(PAD 1.3) (0.3)	(PAD 1.3) (0.3)	(0.6)	(0.2)	18µm (0.35)	18µm (0.35)	(0.35)
							35µm (0.45)	35µm (0.45)	
CLASE 4	(0.5)	(PAD 0.9) (0.2)	(PAD 1.0) (0.25)	(PAD 1.0) (0.25)	(0.45)	(0.15)	18µm (0.20)	18µm (0.20)	(0.3)
							35µm (0.30)	35µm (0.30)	
CLASE 5	(0.3)	(PAD 0.65) (0.175)	(PAD 0.70) (0.2)	(PAD 0.70) (0.2)	VÍAS 18µm (0.325) INSECCIÓN (0.35) VÍAS 35µm (0.375) INSECCIÓN (0.4)	(0.1)	18µm (0.15)	18µm (0.15)	(0.2)
							35µm (0.2)	35µm (0.2)	
CLASE 6	(0.2)	(PAD 0.55) (0.175)	(PAD 0.60) (0.2)	(PAD 0.60) (0.2)	VÍAS 18µm (0.295) INSECCIÓN (0.32) VÍAS 35µm (0.375) INSECCIÓN (0.4)	(0.1)	18µm (0.12)	18µm (0.12)	(0.2)
							35µm (0.15)	35µm (0.2)	
CLASE 7	18µm (0.15)	18µm (0.1)	18µm (0.1)	18µm (0.15)	(0.25)	(0.1)	(0.1)	(0.1)	18µm (0.1)
	35µm (0.2)	35µm (0.125)	35µm (0.125)	35µm (0.2)					35µm (0.125)
ESQUEMA									

PCBs CON PARÁMETROS ESPECIALES CONSULTAR.